Electronic Patent Application Fee Transmittal							
Application Number:	10	10813778					
Filing Date:	31-Mar-2004						
Title of Invention:	METHOD FOR MANUFACTURING MOUNTING SUBSTRATE AND METHOD FOR MANUFACTURING CIRCUIT DEVICE						
First Named Inventor/Applicant Name:	Kiyoshi Mita						
Filer:	Samuel Borodach/Roselynn Scarfo						
Attorney Docket Number:	14225-048001 / F1040146US						
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Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
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